

Preliminary

3V LOW NOISE AMPLIFIER

RF2371

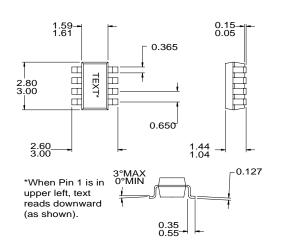
Typical Applications

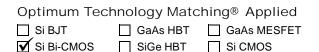
- GSM Handsets
- CDMA Handsets
- TDMA Handsets

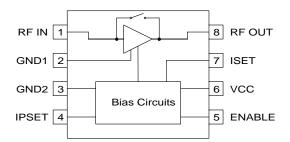
- IF or RF Buffer Amplifiers
- Driver Stage for Power Amplifiers
- Oscillator Loop Amplifiers

Product Description

The RF2371 is a general purpose, low-cost, high performance low noise amplifier designed for operation from a 2.7V to 4V supply with low current consumption. The attenuation of the device is controlled when in power down mode, providing a known gain step. The RF2371 is available in a small industry-standard SOT23-8 surface mount package, enabling compact designs which conserve board space. The design features a highly accurate PTAT (Proportional To Absolute Temperature) biasing scheme using bandgap cells.







Functional Block Diagram

Package Style: SOT23-8

Features

- 700 MHz to 2000 MHz Operation
- 2.7V to 3.6V Single Supply
- +5dBm Input IP3 at 3.0mA
- 12dB Gain at 1950MHz
- 1.8dB Noise Figure at 1950MHz
- 17dB Gain Step

Ordering Information RF2371 3V Low Noise Amplifier RF2371 PCBA Fully Assembled Evaluation Board

 RF Micro Devices, Inc.
 Tel (336) 664 1233

 7625 Thorndike Road
 Fax (336) 664 0454

 Greensboro, NC 27409, USA
 http://www.rfmd.com

Absolute Maximum Ratings

Parameter	Rating	Unit			
Supply Voltage	4.0	V			
Supply Current	20	mA			
Operating Ambient Temperature	-40 to +85	°C			
Storage Temperature	-40 to +150	°C			



RF Micro Devices believes the furnished information is correct and accurate at the time of this printing. However, RF Micro Devices reserves the right to make changes to its products without notice. RF Micro Devices does not assume responsibility for the use of the described product(s).

Parameter	Specification		Unit	Condition		
Falameter	Min.	Тур.	Max.	Unit	Condition	
Overall					T=27°C, V _{CC} =2.7V, V _{ISELECT} =0V,	
Overall					V _{ENABLE} =2.7V	
Frequency Range		700 to 2000		MHz		
LNA Performance					Freq=1.95GHz	
Gain	10.5	12.5		dB		
Noise Figure		1.6		dB		
Input IP3	+4	+6		dBm	At 2.9mA	
Input P1dB		-14		dBm		
Input VSWR		5:1		dB	(Noise match)	
Output VSWR			1.5:1	dB		
Off Mode Gain		-5.0		dB	V _{ENABLE} =0V	
Gain		17		dB	Freq=836MHz	
Noise Figure		1.6		dB		
Input IP3		0		dBm		
Current Control						
Internal Current Setting "ON"		CMOS Low		V	Voltage on ISELECT	
External Current Setting "ON"		CMOS High		V	Voltage on ISELECT	
Current into ISELECT			1	μA	V _{ISELECT} =2.7V	
Power Control						
Power "ON" Voltage		CMOS High		V	Voltage on ENABLE	
Power "OFF" Voltage		CMOS Low		V	Voltage on ENABLE	
Current into ENABLE			1	μA	V _{ENABLE} =2.7V	
Power Supply						
Operating Voltage		2.7 to 3.6		V		
Operating Current		2.9	5	mA	V _{CC} =2.7V, Internal current setting	
Leakage Current			1	μA	V _{ENABLE} =0V	

4

Pin	Function	Description	Interface Schematic
1	RF IN	RF input pin. This pin is not internally DC blocked and requires an external blocking capacitor.	
2	GND1	Ground connection for the LNA. Keep traces physically short and con- nect immediately to ground plane for best performance.	
3	GND2	Ground connection for the bias circuits.	
4	IPSET	This pin selects the internal current setting when CMOS level "low", and the external current setting when this pin is CMOS level "high".	
5	ENABLE	Power down control. This is a CMOS input. When this pin is CMOS "high" the device is enabled. When the level is CMOS "low" the device is shut off and a controlled attenuator is turned on.	
6	VCC	Power supply for the bias circuits.	
7	ISET	This pin sets the current for the device.	
8	RF OUT	RF output pin. Bias for the LNA is provided through this pin, hence it should be connected to VCC through an inductor.	

Application Information

The RF2371 may be configured to use either the internal current setting or the external current setting. This choice is made by asserting IPSET, pin 4, to CMOS level "low" for the internal current setting or CMOS level "high" for the external current setting.

Internal Current Setting

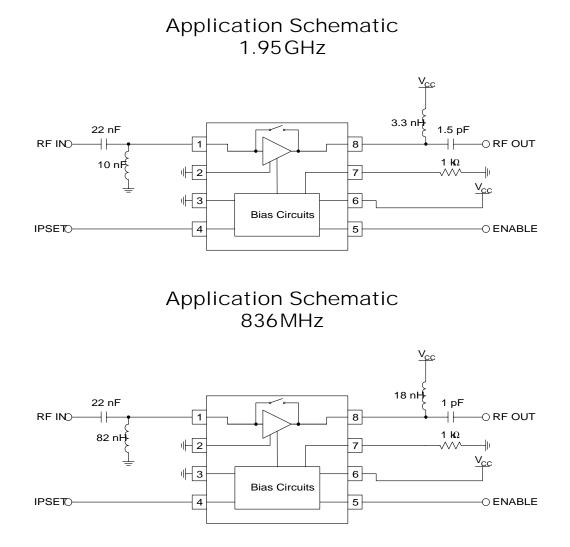
When IPSET is set to CMOS "low", the internal current settings are chosen. This current draw is typically 2.9mA. In this mode, the resistorR1 may be removed from the evaluation board schematic and ISET left floating. The condition for optimal IP3 is to use the internal current setting option and leave the ISET pin open (no connect).

External Current Setting

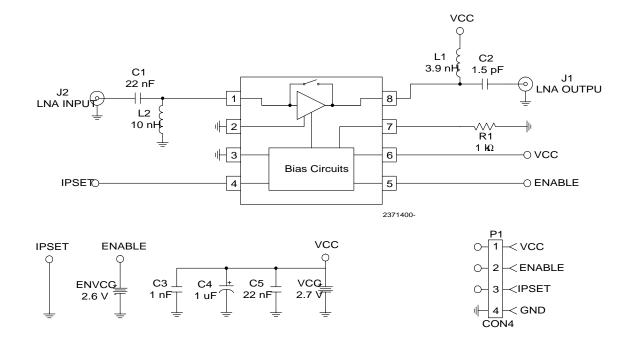
The external current setting is configured by using the series resistor between ISET, pin7, and ground (refer to resistor R1 in evaluation board schematic). The value of the resistor may be changed to permit various operating currents up to a maximum allowable current of 20mA. The table below gives approximate minimum R1 values to allow the 20mA maximum current draw at various operating voltages.

Note: When the internal current setting was selected, the part tested drew 4.4mA, which is higher than typical					
(2.9mA). Thus values of R1 given vary from part to part.					
V _{CC} (V)	Resistor R1 (Ω)	Current Draw (mA)			
2.7	2.4k	20.1			
3.0	2.7k	20.1			
3.3	3.0k	20.0			
3.6	3.3k	19.8			

4







Evaluation Board Layout Board Size 0.833" x 1.009" Board Thickness 0.031", Board Material FR-4

